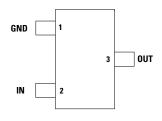
### 5V, 4A eFuse with Over Voltage and Over Current Protection







#### **Pinout Designation**

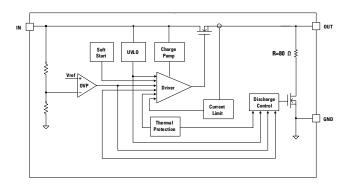


SOT23\_3L TOP VIEW

### **Pin Description**

Pin no.	Pin Name	Description
1	GND	Ground pin
2	IN	Input pin
3	OUT	Output pin. OUT is discharged to GND through an internal $80\Omega$ resistor during OVP event.

#### **Functional Block Diagram**



### **Description**

The integrated load switching of the LS0504EVT233 provides robust, input over-current protection to the downstream circuit systems. The device comes with built-in over-voltage protection and internal soft start. The switch's low RDS(ON) minimizes the system's power loss.

In the event of input over-voltage, LS0504EVT233 immediately turns off the switch to prevent the downstream system from the stress of excessively high voltage. Internal soft-start ensures a smooth output voltage ramp-up and limits the input inrush current.

### **Features & Benefits**

- Wide Input Voltage Range from 2.7V to 6V
- 30V Maximum Input / Output Voltage
- 50mΩ Low RDS(ON)
   Protection Switch
- Built-in Over-Voltage Protection
- Discharge Output at OVP

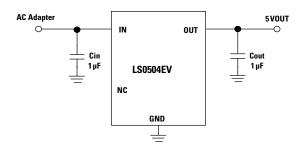
- Internal Soft-Start
- Thermal Shutdown
- Continuous Current 3A; Peak Current 4A
- Hiccup Mode Protection for Over Load or Short Circuit
- SOT23\_3L Package
- Pb-Free and RoHS compliant

### **Applications**

- Bluetooth Headsets
- Wearable Device
- Tablet PC

- Charging Cable
- Battery Devices
- Adapter Powered Devices

### **Typical Applications**





### 5V, 4A eFuse with Over Voltage and Over Current Protection

### **Absolute Maximum Rating (Reference to GND)**

Symbol	Value	Units
IN, OUT	-0.3 to +30	V
ILIM	-0.3 to +6.5	V
ESD, Human Body Model (HBM)	±2000	V
Junction Temperature Range	-40 to +150	°C
Storage Temperature Range	-65 to +150	°C
Lead Temperature (Soldering 10s)	260	°C

#### Notes:

- 1. Stress exceeding those listed "Absolute Maximum Ratings" may damage the device.
- 2. ESD HBM testing per JESD22-A114F

### **Recommend Operating Conditions**

Symbol	Value	Units
Input Voltage (IN)	+2.7 to +28	V
Junction Temperature Range	+125	°C

<sup>\*</sup> Notes: The device is not guaranteed to function outside of the recommended operating conditions.

#### Thermal information

Symbol	Value	Units
Maximum Power Dissipation (T <sub>A</sub> =25°C)	0.88	W
Thermal Resistance ( $\theta_{_{ m JA}}$ )	142	°C/W
Thermal Resistance ( $\theta_{ m JC}$ )	74	°C/W

#### Notes

- 1. Measured on JESD51-7, 4-Laver PCB.
- **2.** The maximum allowable power dissipation is a function of the maximum junction temperature  $T_{J,MMX'}$  the junction to ambient thermal resistance  $\theta_{JM}$  and the ambient temperature TA. The maximum allowable continuous power dissipation at any ambient temperature is calculated by  $P_{0,JMX'} = T_{J,MMX'} T_{J} / \theta_{JM}$ . Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.

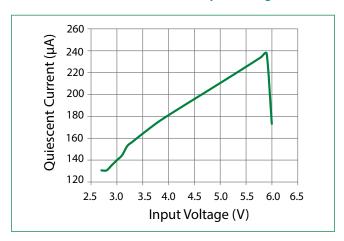
### Electrical Characteristics ( $T_A = +25$ °C, $V_{IN}=5V$ , $C_{IN}=1\mu F$ , unless otherwise specified)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V <sub>IN</sub>	Input Voltage Range		2.7		28	V
I <sub>BIAS</sub>	Quiescent Current			200	260	μΑ
$V_{UV}$	Input Under-voltage Threshold			2.48		V
$V_{\text{UVHYS}}$	Input Under-voltage Hysteresis			180		mV
V <sub>ov</sub>	Input Over-voltage Threshold			6.2		V
$V_{ov}$	Input Over-voltage Hysteresis			330		mV
T <sub>ss</sub>	Soft-start Slew Rate Time			230		μs
l <sub>out</sub>	Continuous Output Current		0		3	А
R <sub>Disch</sub>	OUT Discharging Resistance	V <sub>IN</sub> =6.5V		80		Ω
T <sub>SD</sub>	Thermal Shutdown Temperature			160		°C
T <sub>HYS</sub>	Thermal Shutdown Hysteresis			40		°C

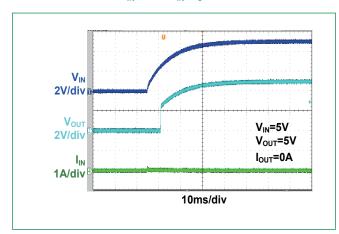


## 5V, 4A eFuse with Over Voltage and Over Current Protection

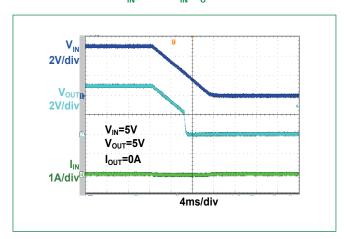
### **Quiescent Current vs. Input Voltage**



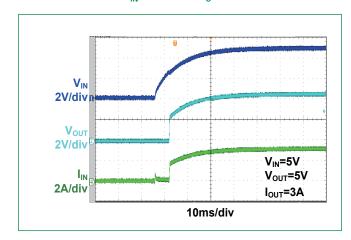
 $V_{IN}$  On (5 $V_{IN}$ ,  $I_{O}$ =0A)



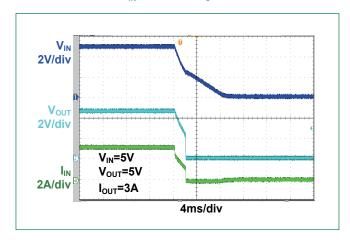
 $V_{IN}$  Off (5 $V_{IN}$ ,  $I_{O}$ =0A)



 $V_{IN}$  On (5Vin,  $I_0$ =3A)



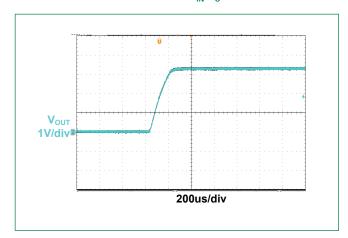
 $V_{IN}$  Off (5Vin,  $I_0$ =3A)



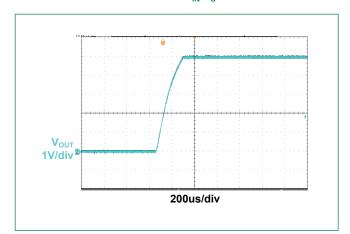


## 5V, 4A eFuse with Over Voltage and Over Current Protection

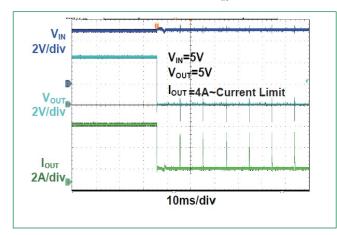
Soft Start (3.3 $V_{IN}$ ,  $I_{O}$ =0A)



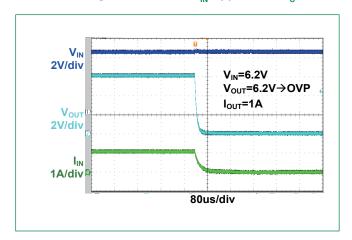
Soft Start (5V<sub>IN</sub>, I<sub>o</sub>=0A)



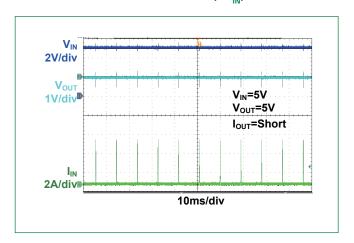
**Current Limit (5V<sub>IN</sub>)** 



Over Voltage Protection (5 $V_{IN}$  Application,  $I_{O}$ =1A)



Short Protection (5V<sub>IN</sub>)





### 5V, 4A eFuse with Over Voltage and Over Current Protection

### **Detailed Description**

The LS0504EVT233 is a fully integrated load switch with built-in over-voltage protection, internal soft-start, and current limit. When the input voltage is within the valid range (2.7V ~28V), the output pin OUT will ramp up with a fixed slew rate defined by an internal soft start. After OUT ramps up to the input level, the internal load switch is fully turned on and ready to supply power to the system. LS0504EVT233 continuously monitors the system load current through the switch when powering on. Once the load current reaches the current limit, LS0504EVT233 will regulate the load current for 60µs to prevent the load current from running away. After 60µs, if the current limit condition sustains, LS0504EVT233 will turn off the load switch, wait for 8ms and then try to restart. In the event of system short circuit failure, the load current could jump significantly higher than the current limit. Whenever the load current is 2A larger than the current limit level, LS0504EVT233 immediately turns off the load switch to prevent a disastrous outcome, then also for 8ms before it tries to restart. LS0504EVT233 has an internal input OVP to protect the system from being stressed by excessively high voltage. Once it detects input voltage is higher than the built-in over-voltage threshold, LS0504EVT233 immediately turns off the load switch. The load switch will be automatically turned on once the input voltage falls within the valid range. The LS0504EVT233 also has thermal shutdown protection; when device temperature (T<sub>J</sub>) exceeds T<sub>SHDN</sub>, typically 160°C, the thermal shutdown circuitry will shut down the internal MOSFET, thereby disconnecting the load from the input supply. The LS0504EVT233 will remain off during a cooling period until the device temperature falls below T<sub>SHDN</sub> -40°C, after which it will attempt to restart.

### **Input and Output Capacitor Selection**

The LS0504EVT233 require ≥1µF input and output capacitor connected to GND. X7R type capacitors are recommended, but X5R and others may be used.

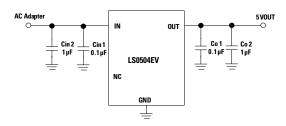
### **PCB Layout Guideline**

- For all applications, a 0.1μF or greater ceramic decoupling capacitor is recommended between IN terminal and GND, and a 0.1μF or greater ceramic decoupling capacitor is recommended between OUT terminal and GDN. For hot-plug applications, where input power path inductance is negligible, this capacitor can be eliminated/minimized.
- The optimum placement of decoupling capacitor is closest to the IN and GND terminals of the device. Care must be taken to minimize the loop area formed by the bypass-capacitor connection, the IN terminal, and the GND terminal of the IC.
- High current carrying power path connections should be as short as possible and should be sized to carry at least twice the full-load
- The GND terminal must be tied to the PCB ground plane at the terminal of the IC. The PCB ground should be a copper plane or island on the board
- Obtaining acceptable performance with alternate layout schemes is possible; however, this layout has been shown to produce good results and is intended as a guideline.



## 5V, 4A eFuse with Over Voltage and Over Current Protection

### **Application Schematic**



### **Bill of Materials**

Qty	Ref	Value	Description	Package
2	CIN2, CO2	1μF	Ceramic Capacitor, 35V, X5R	0805
2	CIN1, CO1	0.1µF	Ceramic Capacitor, 35V, X5R	0603
1	R1	NC	Resistor, ±1%	0603
1	U1	LS0504EVT233	eFuse IC	SOT23-3

### **Soldering Parameters**

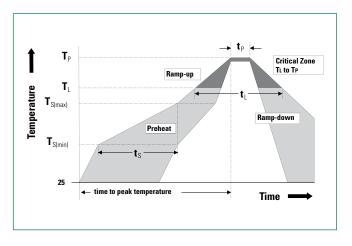
Average ramp	up rate (Tsmin toT <sub>p</sub> )	1~2°C/second, 3°C/second max.
	-Temperature Min (T <sub>s(min)</sub> )	150°C
Preheat & Soak	-Temperature Max (T <sub>s(max)</sub> )	200°C
	-Time (min to max) (t <sub>s</sub> )	60 – 120 secs
Time maintained above	- Temperature(T <sub>L</sub> )	217°C
	-Time(t <sub>L</sub> )	60~150 seconds
Peak Temperat	See Classification Temp intable1	
Time within 5	30 seconds max	
Ramp-down R	6°C/second max	
Time 25°C to	8 minutes Max.	

#### Notes:

- 1. Tolerance for peak profile Temperature(Tp) is defined as a supplier minimum and a user maximum.
- 2. Tolerance for time at peak profile temperature (tp)is defined as a supplier minimum and a user maximum.

### **Ordering Information**

Part Number	Package	Min. Order Qty.
LS0504EVT233	SOT23_3L	3000/Tape & Reel



### Pb-freeProcess –Classification Temperatures (T<sub>c</sub>)

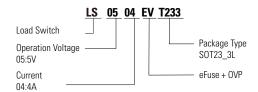
Package Thickness	Volume mm³ <350	Volume mm³ 350-2000	Volume mm³ >2000
<1.6mm	260°C	260°C	260°C
1.6mm-2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C
-	3,4,5,6	NC	No Connection

**Note:** For all temperature information, please refer to topside of the package, measured on the package body surface.

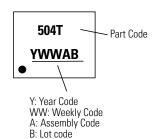


### 5V, 4A eFuse with Over Voltage and Over Current Protection

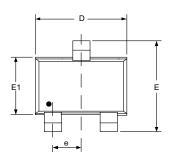
### **Part Numbering**

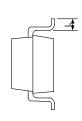


#### **Part Marking**

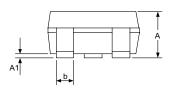


#### Dimensions - SOT23\_3L

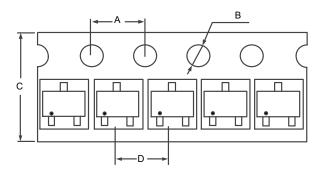


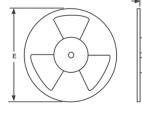


Dimension	Millin	Millimeters		Inches	
Dimension	MIN	MAX	MIN	MAX	
А	-	1.45	-	0.057	
A1	0.00	0.15	0.000	0.006	
b	0.30	0.50	0.012	0.020	
D	2.90		0.1	114	
E1	1.60		0.0	)63	
е	0.95		0.0	)37	
Е	2.60	3.00	0.102	0.118	
L	0.30	0.60	0.012	0.024	



### Carrier Tape & Reel Specification — SOT23\_3L







Symbol	Millimeters
Α	4.0
В	1.5
С	8.0
D	4.0
E	7 inch
F	9.0

Feeding direction ----

Product Disclaimer - Littelfuse products are not designed for, and shall not be used for, any purpose (including, without limitation, automotive, military, aerospace, medical, life-saving, life-sustaining or nuclear facility applications, devices intended for surgical implant into the body, or any other application in which the failure or lack of desired operation of the product may result in personal injury, death, or property damage) other than those expressly set forth in applicable Littelfuse product documentation. Warranties granted by Littelfuse shall be deemed void for products used for any purpose not expressly set forth in applicable Littelfuse documentation. Littelfuse shall not be liable for any claims or damages arising out of products used in applications not expressly intended by Littelfuse as set forth in applicable Littelfuse documentation. The sale and use of Littelfuse products used in applicable Littelfuse as a set forth in applicable Littelfuse according to the complex of the sale and use of Littelfuse products used in applications not expressly intended by Littelfuse as set forth in applicable Littelfuse according to the complex of the c

